

MBR30L60CT / MBR30L60FCT

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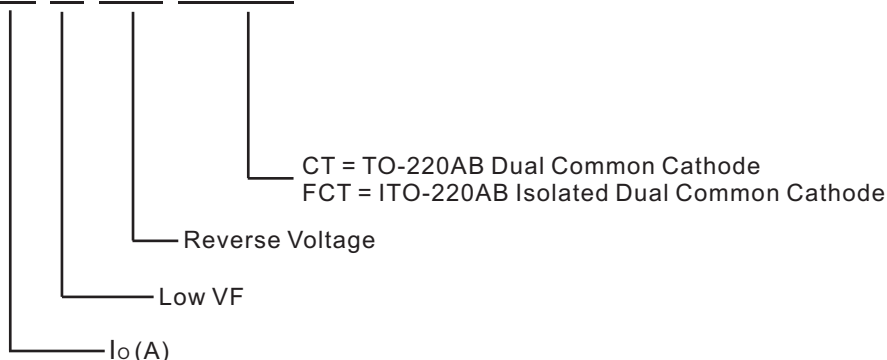
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Part Nomenclature

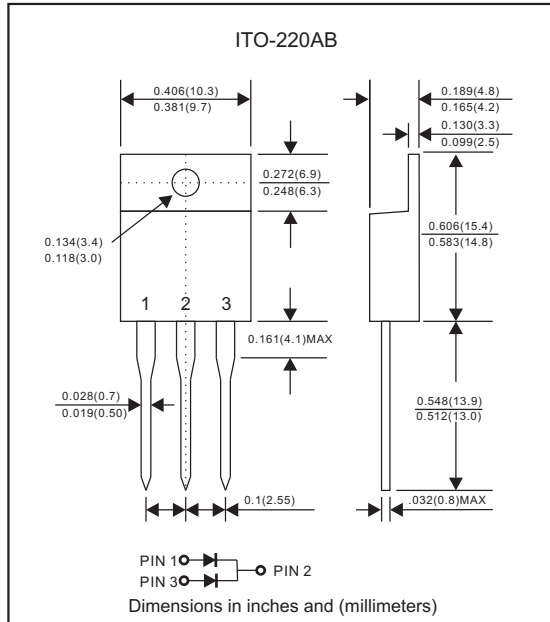
MBR30 L 60 XXX



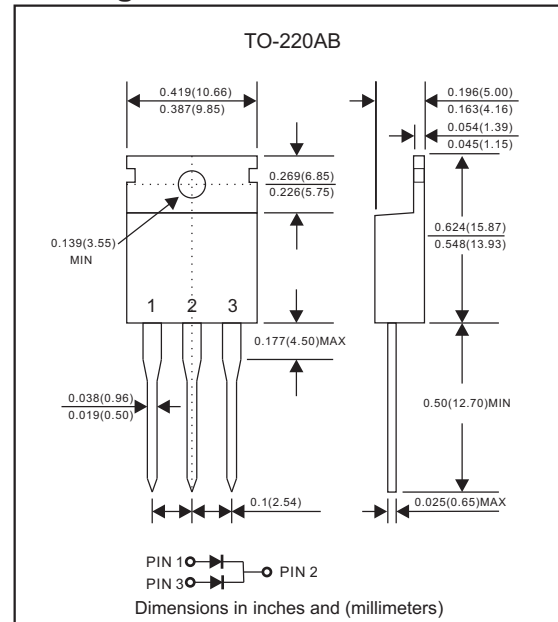
MBR30L60CT / MBR30L60FCT

30A High Barrier Low VF Power Schottky Rectifiers - 60V

Package outline



Package outline



Features

- High current density schottky.
- 150°C operating junction temperature.
- Offer 15A half wave and 30A full wave rectification.
- Low power loss, high efficiency.
- Low forward voltage drop.
- High current capability
- High surge capability.
- Guardring for overvoltage protection.
- Low stored charge majority carrier conduction
- Lead-free parts meet RoHS requirements.
- Suffix "-H" indicates Halogen-free part, ex. MBR30L60CT-H.

Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : JEDEC ITO-220AB or TO-220AB molded plastic body over passivated chip
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guranteed
- Polarity: As marked
- Mounting Position : Any
- Weight : ITO-220AB Approximated 1.70 gram
- Weight : TO-220AB Approximated 2.10 gram

Maximum ratings (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

| PARAMETER | Symbol | MBR30L60CT | MBR30L60FCT | Unit |
|--|-----------|-------------|-------------|-------|
| Maximum repetitive peak reverse voltage | V_{RRM} | 60 | | Volts |
| Maximum RMS voltage | V_{RMS} | 42 | | Volts |
| Maximum DC blocking voltage | V_{DC} | 60 | | Volts |
| Maximum average forward rectified current See Fig.1 | I_O | 30 | | A |
| Peak forward surge current 8.3ms single half sine-wave | I_{FSM} | 250 | | A |
| Operating junction temperature range | T_J | -65 to +150 | | °C |
| Storage temperature range | T_{STG} | -65 to +150 | | °C |

Electrical characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

| PARAMETER | Symbol | MBR30L60CT | MBR30L60FCT | Unit |
|--|--------|------------------------------|-------------|-------|
| Maximum forward voltage per leg at $I_F=15\text{A}$ $T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ at $I_F=30\text{A}$ $T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ | V_F | 0.55 0.53 0.90 0.80 | | Volts |
| Maximum reverse current at rated V_{DC} per leg $T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ | I_R | 0.1 15 | | mA |

Thermal characteristics

| PARAMETER | Symbol | MBR30L60CT | MBR30L60FCT | Unit |
|---|-----------------|------------|-------------|------|
| Typical thermal resistance junction to case per leg | $R_{\theta JC}$ | 2.0 | 4.0 | °C/W |

Rating and characteristic curves (MBR30L60CT / MBR30L60FCT)

Fig. 1 - Forward Current Derating Curve

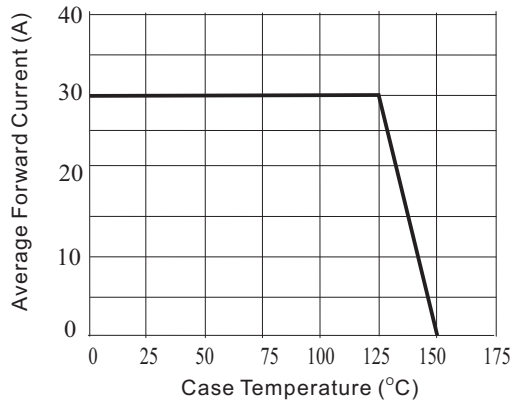


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

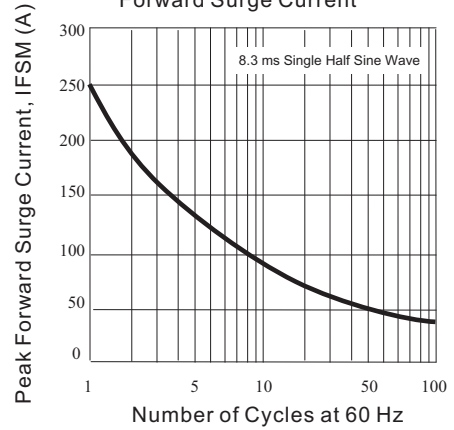


Fig. 3 - Typical Forward Characteristics

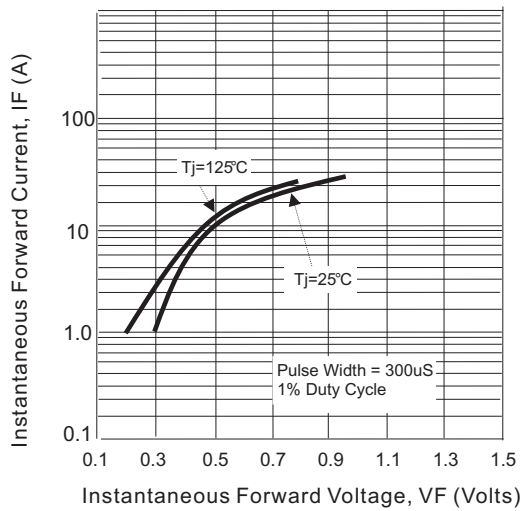
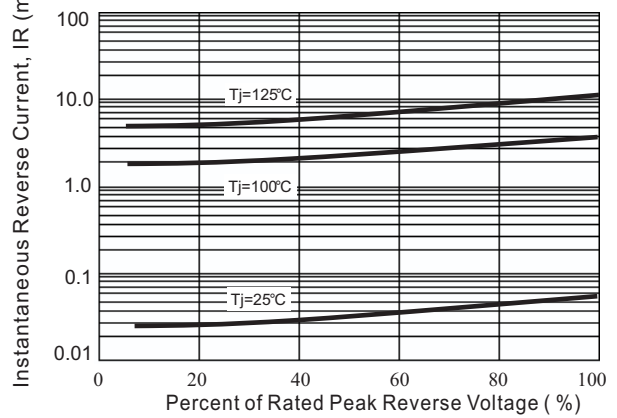


Fig. 4 - Typical Reverse Characteristics



MBR30L60CT / MBR30L60FCT

Pinning information

| Pin | Simplified outline | Symbol |
|--|--------------------|--------|
| Pin1 anode Pin2 cathode Pin3 anode | | |

Marking

| Type number | Marking code |
|-------------|--------------|
| MBR30L60CT | MBR30L60CT |
| MBR30L60FCT | MBR30L60FCT |

Tube packing

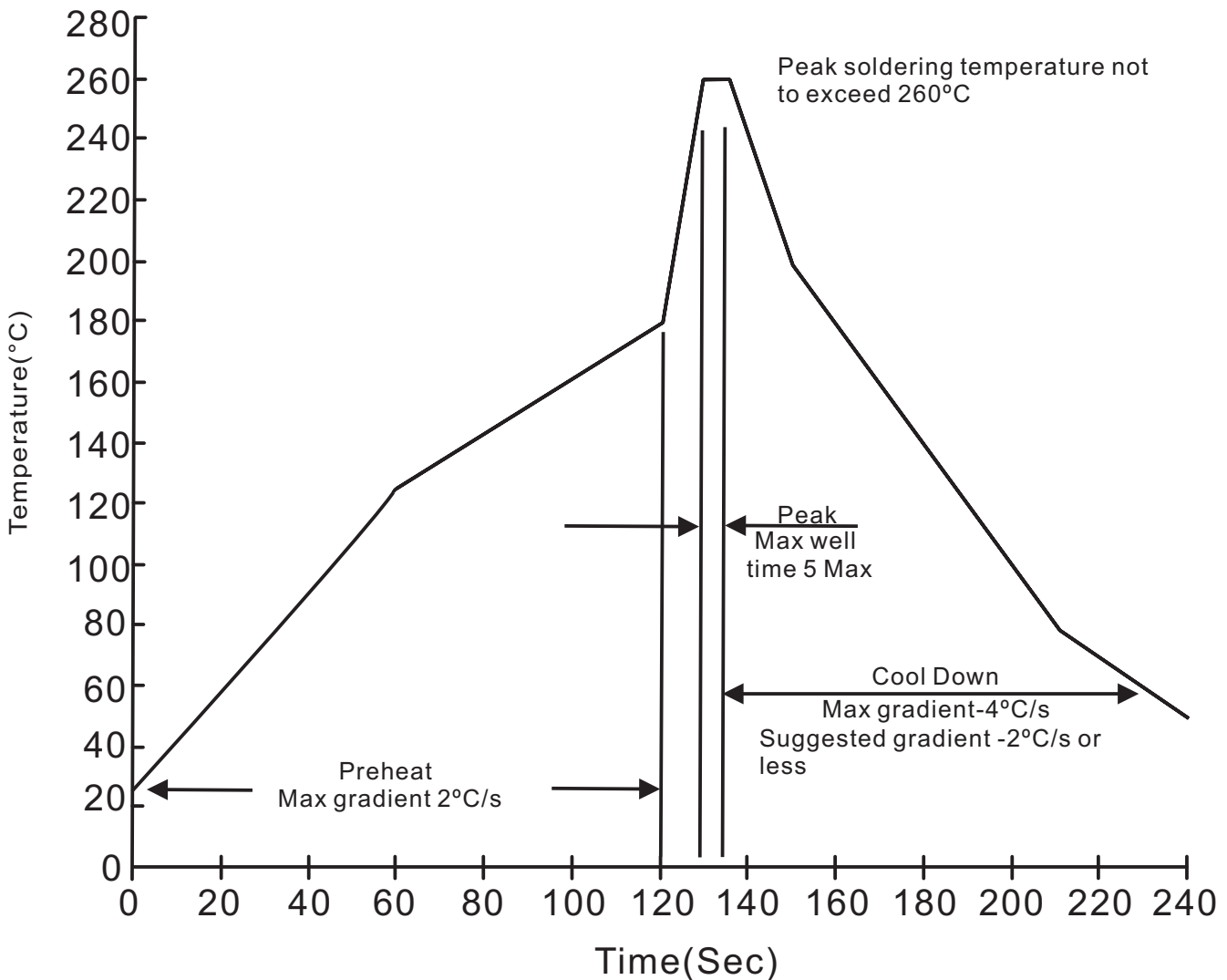
| PACKAGE | TUBE (pcs) | TUBE SIZE (m/m) | BOX (pcs) | INNER BOX (m/m) | CARTON SIZE (m/m) | CARTON (pcs) | APPROX. GROSS WEIGHT (kg) |
|-----------|------------|-----------------|-----------|-----------------|-------------------|--------------|---------------------------|
| ITO-220AB | 50 | 525*32*7.0 | 1000 | 555*150*40 | 580*230*175 | 5,000 | 15.0 |

| PACKAGE | TUBE (pcs) | TUBE SIZE (m/m) | BOX (pcs) | INNER BOX (m/m) | CARTON SIZE (m/m) | CARTON (pcs) | APPROX. GROSS WEIGHT (kg) |
|----------|------------|-----------------|-----------|-----------------|-------------------|--------------|---------------------------|
| TO-220AB | 50 | 525*32*7.5 | 1000 | 555*150*40 | 580*230*175 | 5,000 | 15.0 |

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Suggested thermal profiles for soldering processes

1. Lead free temperature profile wave-soldering



MBR30L60CT / MBR30L60FCT**High reliability test capabilities**

| Item Test | Conditions | Reference |
|-----------------------------------|--|-------------------------------|
| 1. Solder Resistance | at $260\pm 5^{\circ}\text{C}$ for $10\pm 2\text{sec}$. immerse body into solder $1/16''\pm 1/32''$ | MIL-STD-750D METHOD-2031 |
| 2. Solderability | at $245\pm 5^{\circ}\text{C}$ for 5 sec. | MIL-STD-202F METHOD-208 |
| 3. High Temperature Reverse Bias | $V_R=80\%$ rate at $T_J=150^{\circ}\text{C}$ for 168 hrs. | MIL-STD-750D METHOD-1038 |
| 4. Forward Operation Life | Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs. | MIL-STD-750D METHOD-1027 |
| 5. Intermittent Operation Life | $T_A = 25^{\circ}\text{C}$, $I_F = I_o$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles. | MIL-STD-750D METHOD-1036 |
| 6. Pressure Cooker | $15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs. | JESD22-A102 |
| 7. Temperature Cycling | -55°C to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles. | MIL-STD-750D METHOD-1051 |
| 8. Forward Surge | 8.3ms single half sine-wave , one surge. | MIL-STD-750D METHOD-4066-2 |
| 9. Humidity | at $T_A=85^{\circ}\text{C}$, RH=85% for 1000hrs. | MIL-STD-750D METHOD-1021 |
| 10. High Temperature Storage Life | at 175°C for 1000 hrs. | MIL-STD-750D METHOD-1031 |